

Specification	
Part Number:	MC21603A6W-BNMLW
Version:	
Date:	
Revision	

MIDAS

design • manufacture • supply



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# Midas LCD Part Number System

MC COG 132033 A \* 6 W \* \* - S N T L W \* \*

1 2 3 4 5 6 7 8 9 - 10 11 12 13 14 15 16

1 = MC: Midas Components

2 = Blank: COB (chip on board) COG: chip on glass

3 = No of dots (e.g. 240064 = 240 x 64 dots) (e.g. 21605 = 2 x 16 5mm C.H.)

4 = Series

5 = Series Variant: A to Z – see addendum

6 = 3: 3 o'clock 6: 6 o'clock 9: 9 o'clock 12: 12 o'clock

7 = S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)

8 = Character Set

Blank: Standard (English/Japanese)  
C: Chinese Simplified (Graphic Displays only)  
CB: Chinese Big 5 (Graphic Displays only)  
H: Hebrew  
K: European (std) (English/German/French/Greek)  
L: English/Japanese (special)  
M: European (English/Scandinavian)  
R: Cyrillic  
W: European (English/Greek)  
U: European (English/Scandinavian/Icelandic)  
J: Asian/Arabic

9 = Bezel Height (where applicable / available)

	Top of Bezel to Top of PCB	Common (via pins 1 and 2)	Array or Edge Lit
Blank	9.5mm / not applicable	Common	Array
2	8.9 mm	Common	Array
3	7.8 mm	Separate	Array
4	7.8 mm	Common	Array
5	9.5 mm	Separate	Array
6	7 mm	Common	Array
7	7 mm	Separate	Array
8	6.4 mm	Common	Edge
9	6.4 mm	Separate	Edge
A	5.5 mm	Common	Edge
B	5.5 mm	Separate	Edge
D	6.0mm	Separate	Edge
E	5.0mm	Separate	Edge
F	4.7mm	Common	Edge
G	3.7mm	Separate	EL

10 = T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN Z: Zero Power (Bi-Stable)

11 = P: Positive N: Negative

12 = R: Reflective M: Transmissive T: Transflective

13 = Backlight: Blank: Reflective L: LED

14 = Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.

If Z (Zero Power): WB: White on blue GB: Green on black YB: Yellow on black YPB: Yellow on pink and/or blue

15 = Driver Chip: Blank: Standard I: IC T: Toshiba T6963C A: Avant SAP1024B R: Raio RA8835

16 = Voltage Variant: e.g. 3 = 3v

## 2. MECHANICAL CHARACTERISTICS

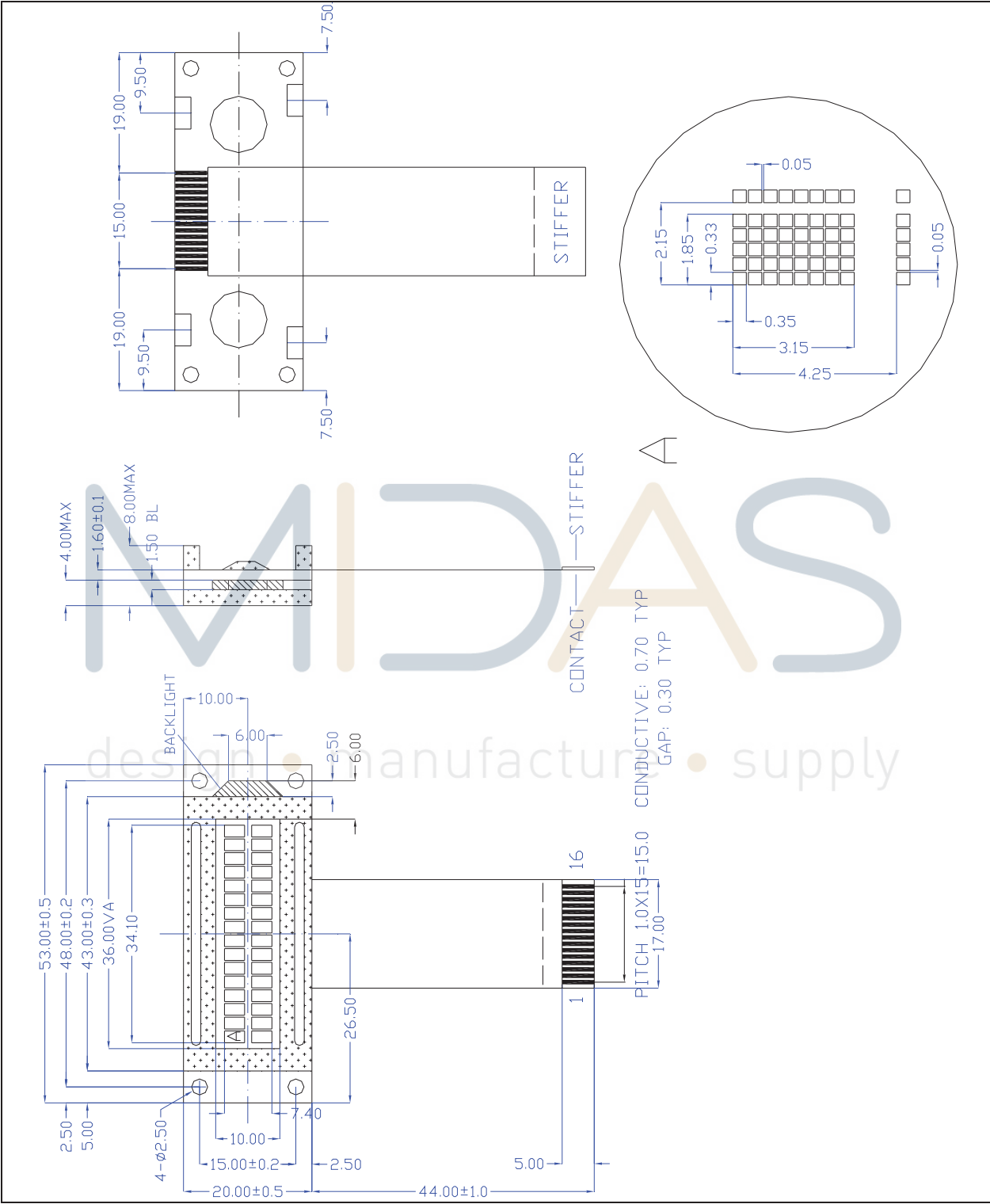
### 2.1 MECHANICAL DATA

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	16 CHARACTERS X 2 LINES	
CHARACTER FORMAT	5 X 7 DOTS PLUS CURSOR	
OUTLINE DIMENSIONS	53.0(W)X20.0(H) X 8.0(T)	mm
EFFECTTVE VIEWING AREA	36.0(W) X 10.0(H)	mm
CHARACTER SIZE	1.85(W) X 3.15(H)	mm
CHARACTER PITCH	2.15(W) X 4.25(H)	mm
DOT SIZE	0.33(W) X 0.35(H)	mm
DOT PITCH	0.38(W) X 0.40(H)	mm
APPROX WEIGHT	20	g

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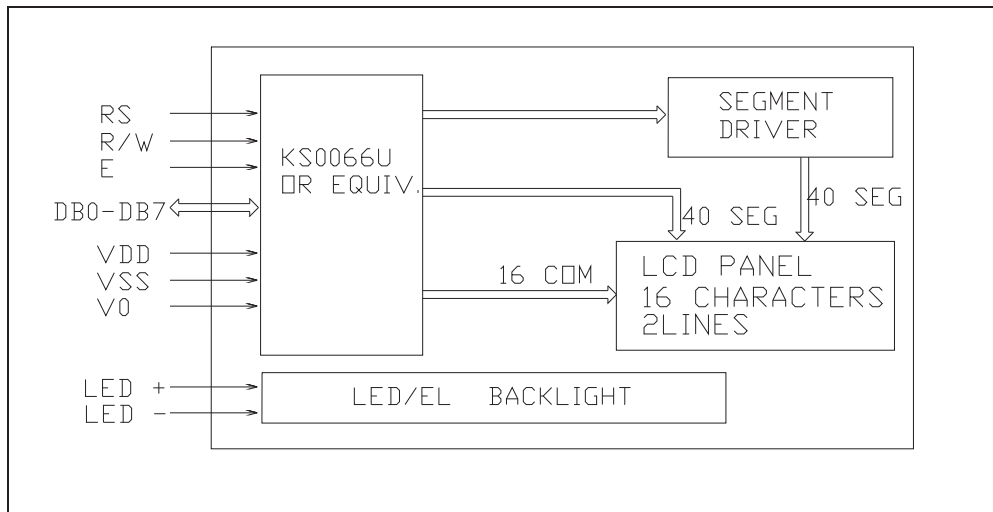
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2.2 MECHANICAL DRAWINGS



### 3. CIRCUIT BLOCK DIAGRAM

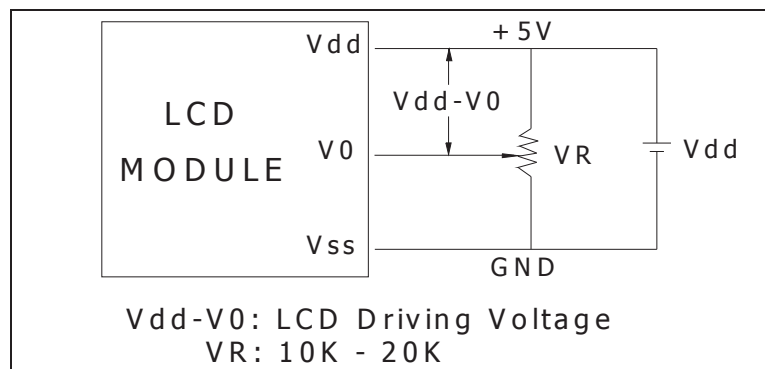
#### 3.1 Electrical Block Diagram



#### 3.2 Pins Definition

PIN	SYMBOL	FUNCTION
1	Vss	Power Supply(GND)
2	Vdd	Power Supply(+5V)
3	Vo	Contrast Adjust
4	RS	Instruction/Data Register Select
5	R/W	Read/Write Select
6	E	Enable Signal
7-14	DB0-DB7	Data Bus Line
15	A	Power Supply for LED B/L(+5.0V)
16	K	Power Supply for LED B/L(0V)

#### 3.3 Power Supply For LCM Driving



### 3.4 Display Character Address Code

POSITION		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
ADDR	LINE1	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
	LINE2	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

\*NOTE: ALL OF THE NUMBERS ARE IN HEX FORMAT

## 4. ABSOLUTE MAXIMUN RATINGS

### 4.1 Electrical Absolute Maximum Ratings

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Supply Voltage (Logic)	Vdd – Vss	-	0	7.0	V
Supply Voltage (LCD Drive)	Vdd – V0	-	0	13.0	V
Input Voltage	Vi	-	-0.3	Vdd +0.3	V

### 4.2 Environmental Absolute Maximum Ratings

ITEM	SYMBOL	CONDITIONS	MIN	MAX	UNIT
Operating Temp	Topr	Wide temp. version	-20	70	deg C
Storage Temp	Ttsg		-30	80	deg C
Humidity Endurance	RH	no Condensation Ta<=40 deg	-	95	%
Vibration	-	100-300Hz, X/Y/Z directions, 1 hour	-	4.9m/ss 0.5g	-
Shock	-	10 mS X/Y/Z direction 1 time each		29.4m/ss 3.0g	-

## 5. ELECTRICAL CHARACTERISTICS

### 5.1 DC Characteristics

Electrical Characteristics at Ta=25 deg C, Vdd = 5V + / - 5%

ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Supply Voltage (logic)	Vdd-Vss	-	4.5	5.0	5.5	V
Supply Voltage (LCD)	Vdd-V0	Vdd = 5V	-	4.6	-	V
Input signal Voltage (for E, DB0-7,R/W,RS)	V-ih	"H" level	2.2	-	Vdd	V
	V-il	"L" level	0	-	0.6	V
Supply Current (logic)	Icc	-	-	1	1.2	mA
Supply Current (LCD)	Io	-	0.15	0.22	0.27	mA

### 5.2 AC Characteristics

TIMING SPECIFICATIONS at Ta = 25 deg C, Vdd = 5V+/-10%, Vss =0V

For Write mode

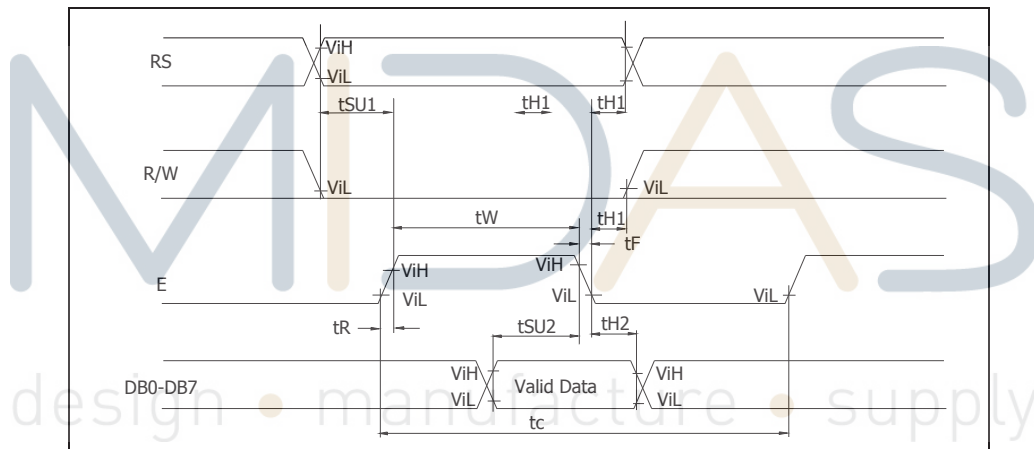
ITEM	SYMBOL	MIN	MAX	UNIT
E cycle time	tc	500	-	ns
E rise time	tR	-	25	ns
E fall time	tF	-	25	ns
E-pulse width (H, L)	tw	220	-	ns
R/W and RS set-up time	tsul	40	-	ns
R/W and RS hold time	tH1	10	-	ns
Data set-up time	tsu2	60	-	ns
Data hold time	tH2	10	-	ns



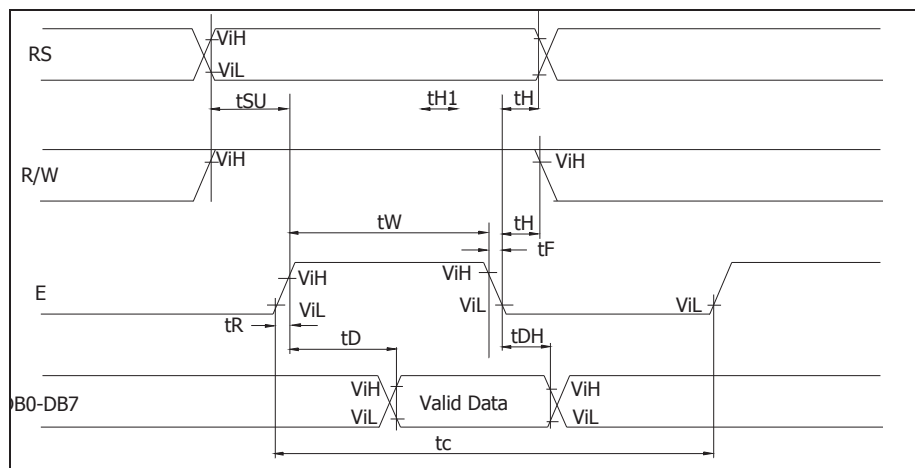
For Read mode

ITEM	SYBOL	MIN	MAX	UNIT
E cycle time	$t_c$	500	-	ns
E rise time	$t_R$	-	25	ns
E fall time	$t_F$	-	25	ns
E-pulse width (H, L)	$t_w$	220	-	ns
R/W and RS set-up time	$t_{su}$	40	-	ns
R/W and RS hold time	$t_H$	10	-	ns
Data output delay	$t_D$	-	120	ns
Data hold time	$t_{DH}$	20	-	ns

### WRITE MODE TIMING DIAGRAM



### READ MODE TIMING DIAGRAM



## 6. BACKLIGHT CHARACTERISTICS

### 6.1 Absolute Maximum Ratings

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Forward Current	Ifm	-	-	20	mA
Reverse Voltage	Vr	-	-	8	V
Power Dissipation	Pd	-	-	100	mW

### 6.2 Operating Parameters

ITEM	SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Forward Voltage	Vf*	If=15mA-	-	4.8	5.0	V
Color		If=15mA-	-	white	-	

- Vf is the voltage applied to Pin15 and Pin16. There is current limiting resistor of 120 ohm on the module PCB. Customer should keep the forward current (If) to be no more than 15mA in the applications.

## 7. ELECTRO-OPTICAL CHARACTERISTICS

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25°C	--	12	--		Note1
Rise Time	tr	25°C	--	160	240	ms	Note2
Fall Time	tf	25°C	--	100	150	ms	note 2
Viewing Angle	θ 1- θ 2	25°C	--	--	60	DEG	Note 3
	Ø1, Ø2		-40	--	40		
Frame Frequency	Ff	25°C	--	70	--	Hz	note 2

Note(1): Contrast ratio is defined under the following condition:

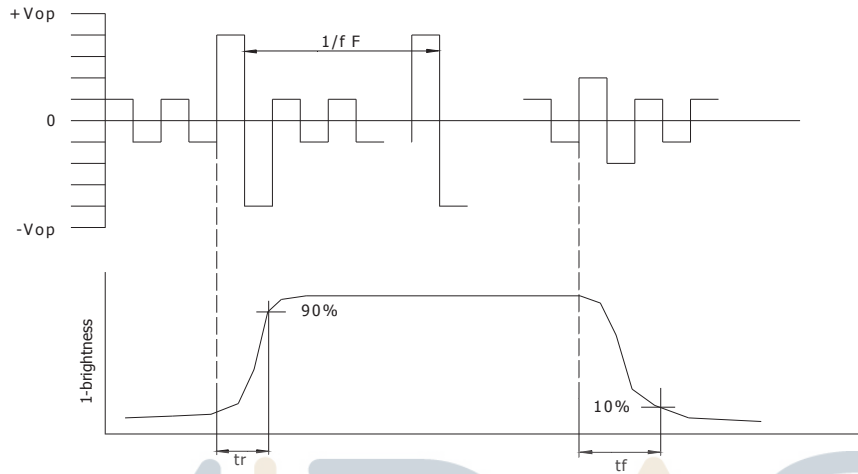
CR=  $\frac{\text{brightness of selected condition}}{\text{brightness of non-selected condition}}$

(a). Temperature-----25C

(b). Frame Frequency-----64Hz

- (c). Viewing angle-----  $\theta = 0, \phi = 0$
- (d). Operating Voltage---5.0V

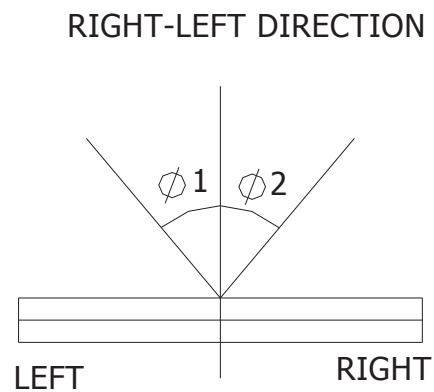
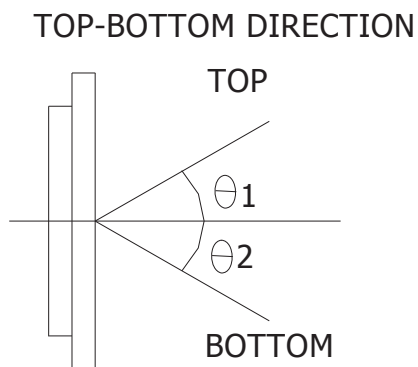
Note(2): definition of response time:



Condition:

- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle-----  $\theta = 0, \phi = 0$
- (d). Operating Voltage---5.0V

Note(3): definition of view angle:



## 8. DISPLAY CONTROL INSTRUCTION

### 8.1 INSTRUCTION TABLE

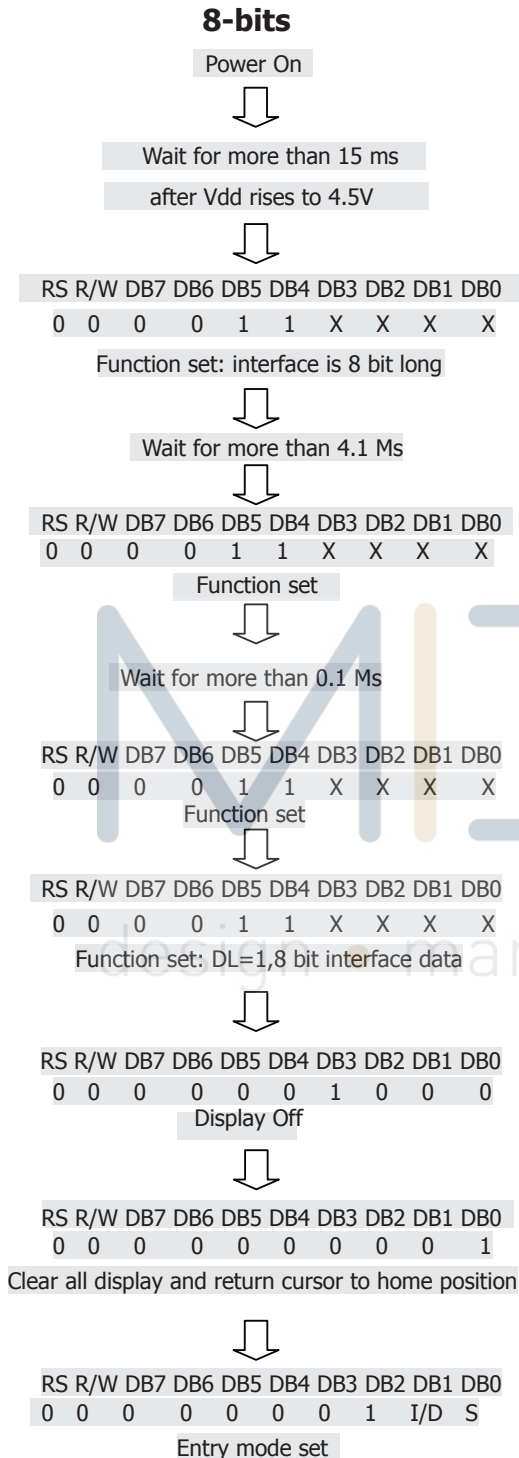
Function	RR	DD	DD	DD	DD	DD	DD	Description	Execu Time* (Max)		
	SW	B	B	B	B	B	B				
	7	6	5	4	3	2	1	0			
Clear Display	0	0	0	0	0	0	0	0	1	Clears entire display and returns the cursor to home position (address 0)	1.64mS
Return Home	0	0	0	0	0	0	0	0	1X	Return the cursor to the home position. DD RAM contents remain unchanged. Set DD RAM address to zero.	1.64mS
Entry mode set	0	0	0	0	0	0	0	1	1S / D	Set cursor moving direction and enable the shift of the display. These operations are performed during data write/read of DD RAM/CG RAM. 1/D=1: increment; 1/D=0: decrement; S=1: whole display shift when data is written.	40μS
Display ON/OFF control	0	0	0	0	0	0	1	D	C B	Set display (D), cursor(C) and blinking of cursor(B) ON/OFF. D=1:display ON; D=0: display OFF. C=1:Cursor ON; C=0: cursot OFF. B=1:Blink ON; B=0, Blink OFF.	40μS
Cursor or Display shift	0	0	0	0	0	1	S	R	X X / / CL	Move the cursor and shift the display without changing DDRAM contents. S/C=1: Display Shift; S/C=0:Cursor move. R/L=1:shift to right; R/L=0:shift to left.	40μS
Function Set	0	0	0	0	1	D	N	F	X X L	Set interface data length (DL), number of display lines (N) and character font (F).DL=1: 8 bits; DL=0: 4 bits. N=1: 2 lines; N=0: 1 lines. F=1: 5X11 dots; F=0: 5X7 dots.	40μS
Set CG RAM add	0	0	0	1					ACG	Set CG RAM address. CG RAM data is sent and received after this setting.	40μS
Set DD RAM Add	0	0	1						ADD	Set DD RAM address. DD RAM data is sent and received after this setting.	40μS
Read BF & Addr	0	1	B						AC	Read BUSY FLAG (BF) and the contents of the address counter. BF=1: internal operation; BF=0: can accept instruction.	0μS
Write Data to RAM	1	0							WRITE DATA	Write data into DD RAM or CG RAM.	40μS**
Read Data from RAM	1	0							READ DATA	Read data from DD RAM or CG RAM.	40μS**

## 8.2 Character Table

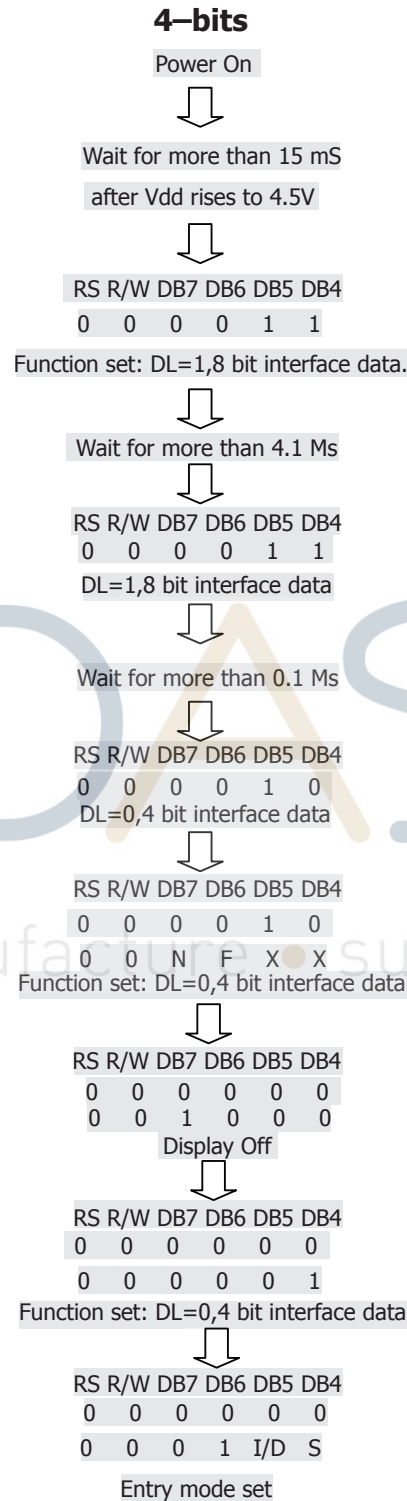
### English/Japanese Character Set (-B0)

Upper 4 bit Lower 4 bit	LLLL	LLHH	LHLH	LLHH	HLHL	LHLH	LHHL	HLHH	HLLL	HLHH	HLHL	HLHH	HHLL	HHHL	HHHL	HHHH		
LLLL				00P`P									ー	タ	ミ	×	P	
LLHH			!	1H0a4									。	ア	チ	△	△	△
LHLH			"	2BRbr									「	イ	ツ	×	×	×
LLHH			#	3CScs									」	ウ	テ	モ	モ	モ
LHLH			\$	4DTdt									、	エ	ト	ト	ト	ト
LHLH			%	5EUeu									・	オ	カ	ユ	ユ	ユ
LHHL			&	6FUfu									ヲ	カ	ニ	ヨ	ヨ	ヨ
LHHH			'	7GWgw									ア	キ	ヌ	ウ	グ	グ
HLLL			(	8H×h×									イ	ウ	ネ	リ	リ	リ
HLLH			)	9IYiy									オ	ク	ル	ル	ル	ル
HLHL			*	JZjz									エ	コ	ロ	レ	レ	レ
HLHH			+	K[k<									オ	サ	ヒ	ロ	ロ	ロ
HHLL			,	<L¥l									カ	シ	フ	ワ	ワ	ワ
HHLH			—	=M[m}									ユ	ヌ	ヘ	シ	シ	シ
HHHL			・	>N^n+									ヨ	セ	ホ	ホ	ホ	ホ
HHHH			/	?0_0+									ウ	ツ	マ	マ	マ	マ

### 8.3 INITIALIZATION BY INSTRUCTION



END OF INITIALIZATION



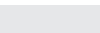
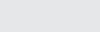
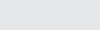
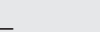
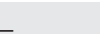

END OF INITIALIZATION

## 8.4 SOFTWARE EXAMPLES

### 8-BIT OPERATION 20 characters X 4 lines

Function	RS RW D7 D6 D5 D4 D3 D2 D1 D0	DISPLAY	DESCRIPTION
Power on delay			Initialization. No display appears.
Function set	0 0 0 0 1 1 0 0 X X		Sets 8-bit operation, 2-line display and 5*7 dots character font.
Display OFF	0 0 0 0 0 0 1 0 0 0		Turn off display.
Display ON	0 0 0 0 0 0 1 1 1 0		Turn on display and cursor.
Entry Mode set	0 0 0 0 0 0 0 1 1 0		Set mode to increment the address by one and to shift the cursor to the right, at the time of write to the DD/CG RAM. Display is not shifted.
Write data to CG/DD RAM	1 0 0 1 0 0 1 1 1 0		Write "N". Cursor incremented by one and shift to right.
Write data to CG/DD RAM	1 0 0 1 0 0 0 1 0 1		Write "E". Cursor incremented by one and shift to right
Write data to CG/DD RAM	. . . . .		Write "L" "Y"
Set DDRAM address	0 0 1 1 0 0 0 0 0 0		Set RAM address so that the cursor is positioned at the head of the 2 <sup>nd</sup> line
Write data to CG/DD RAM	. . . . .		Write "T" "C".
Cursor or display shift	0 0 0 0 0 1 0 0 X X		Shift only the cursor position to the left.
Write data to CG/DD RAM	. . . . .		Write "E" "C" "H"

#### 4-bit operation (4-bits 1 line)

Function	RS RW D7 D6 D5 D4	Display	Description
<b>power on delay</b>			Initialization. No display appears.
<b>Frnction set</b>	0 0 0 0 1 0		Sets to 4-bit operation. In this case, operation is handled as 8-bits by initialization, and only this instruction completes with one write.
<b>Frnction set</b>	0 0 0 0 1 0 0 0 0 0 X X		Sets 4-bit operation, 1-line display and 5*7 dot character font. (number of display lines and character fonts cannot be changed hence after.)
<b>Display ON/OFF Control</b>	0 0 0 0 0 0 0 0 1 1 1 0		Turn on display and cursor.
<b>Entry Mode Set</b>	0 0 0 0 0 0 0 0 0 1 1 0		Turn on display and cursor.
<b>Write data to CG/DD/ARM</b>	1 0 0 1 0 0 1 0 1 1 1 1		Write "O". Cursor incremented by one and shift to right.
same as 8-bit operation			

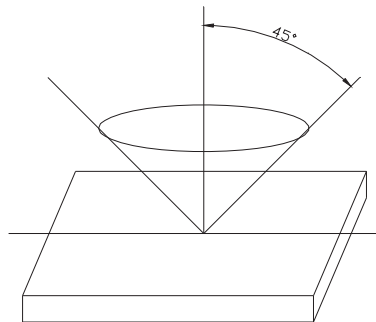
## 9. INSPECTION STANDARDS

### 9.1 Inspection Conditions

The LCD shall be inspected under 40W white fluorescent light.

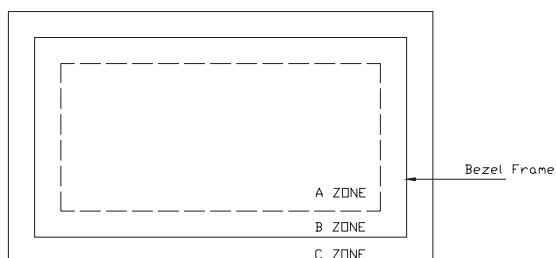
The distance between the eyes and the samples shall be more than 30cm.

All directions for inspecting the sample should be within 45 degree against perpendicular line.





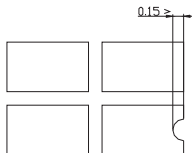
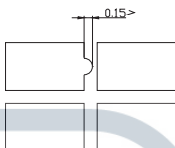
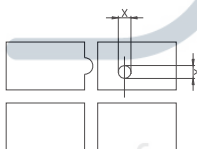
## 9.2 Definition of Applicable Zone



A Zone: Active Display Area  
 B Zone: Area from Bezel Frame to A Zone  
 C Zone: Rest Area of Bezel  
 A Zone + B Zone=Effective Viewing Area

## 9.3 Standards

NO	PARAMETER	CRITERIA				
1	Black and White Spots, Foreign Substances	Round Shape				
		Zone DIMENSION(MM)		Acceptable Number		
				A	B	C
		D≤0.1		*	*	*
		0.1<D≤0.2		5	5	*
		0.2<D≤0.3		0	1	*
		0.3<D		0	0	*
		D=(long+short)/2      * Disregard				
		Line Shape				
		Zone X(mm)      Y(mm)		Acceptable Number		
				A	B	C
		-      0.02≥W		*	*	*
		2.0≥L      0.03≥W		3	3	*
1.0≥L      0.04≥W		1	2	*		
1.0≥L      0.05≥W		0	2	*		
-      0.05<W		Not acceptable				
X: Length      Y: Width      * Disregard						
Total defects shall not exceed 5.						
2	Air Bubbles (Between glass and polarizer)	Zone Dimension(mm)		Acceptable Number		
				A	B	C
		D≤0.1		*	*	*
0.1<D≤0.2		5	5	*		

		<table><tr><td><math>0.2 &lt; D \leq 0.3</math></td><td>0</td><td>1</td><td>*</td></tr><tr><td><math>0.3 &lt; D</math></td><td>0</td><td>0</td><td>*</td></tr></table> <p> *: Disregard Total defects shall not exceed 3.</p>	$0.2 < D \leq 0.3$	0	1	*	$0.3 < D$	0	0	*
$0.2 < D \leq 0.3$	0	1	*							
$0.3 < D$	0	0	*							
3	The Shape of Dot	<p>(1) Dot Shape(with dent)</p> <div></div> <p>As per the sketch of left hand.</p> <p>(2) Dot Shape(with Projection)</p> <div></div> <p>Should not connect to next dot.</p> <p>(3) Pin Hole</p> <div></div> <p><math>(X+Y)/2 &lt; 0.2\text{mm}</math> (less than 0.1mm is not counted)</p> <p>Total defects shall not exceed 5.</p>								
4	Polarizer Scratches	Not to be conspicuous defects.								
5	Polarizer Dirts	If the stains are removed easily from LCD surface,the module is not defective.								
6	Color Variation	Not to be conspicuous defects.								

## 10. PRECAUTIONS IN USING LCM

### 1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handling,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.

- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handling. especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

## **2. Liquid Crystal Display Modules**

### **2.1 Mechanical Considerations**

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

### **2.2. Static Electricity**

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.
- (3). Only properly grounded soldering irons should be used.
- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.
- (5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive ( rubber) mat is recommended.
- (6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

### **2.3. Soldering**

- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature:  $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.
- (6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

### **2.4. Operation**

- (1). The viewing angle can be adjusted by varying the LCD driving voltage  $V_0$ .
- (2). Driving voltage should be kept within specified range; excess voltage shortens display life.
- (3). Response time increases with decrease in temperature.
- (4). Display may turn black or dark blue at temperatures above its operational range; this

is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

### **2.5. Storage**

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

### **2.6. Limited Warranty**

Unless otherwise agreed between AIXUG and customer, AIXUG will replace or repair any of its LCD, which is found to be defective electrically and visually when inspected in accordance with AIXUG acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of AIXUG is limited to repair and/or replacement on the terms set forth above. AIXUG will not be responsible for any subsequent or consequential events.

